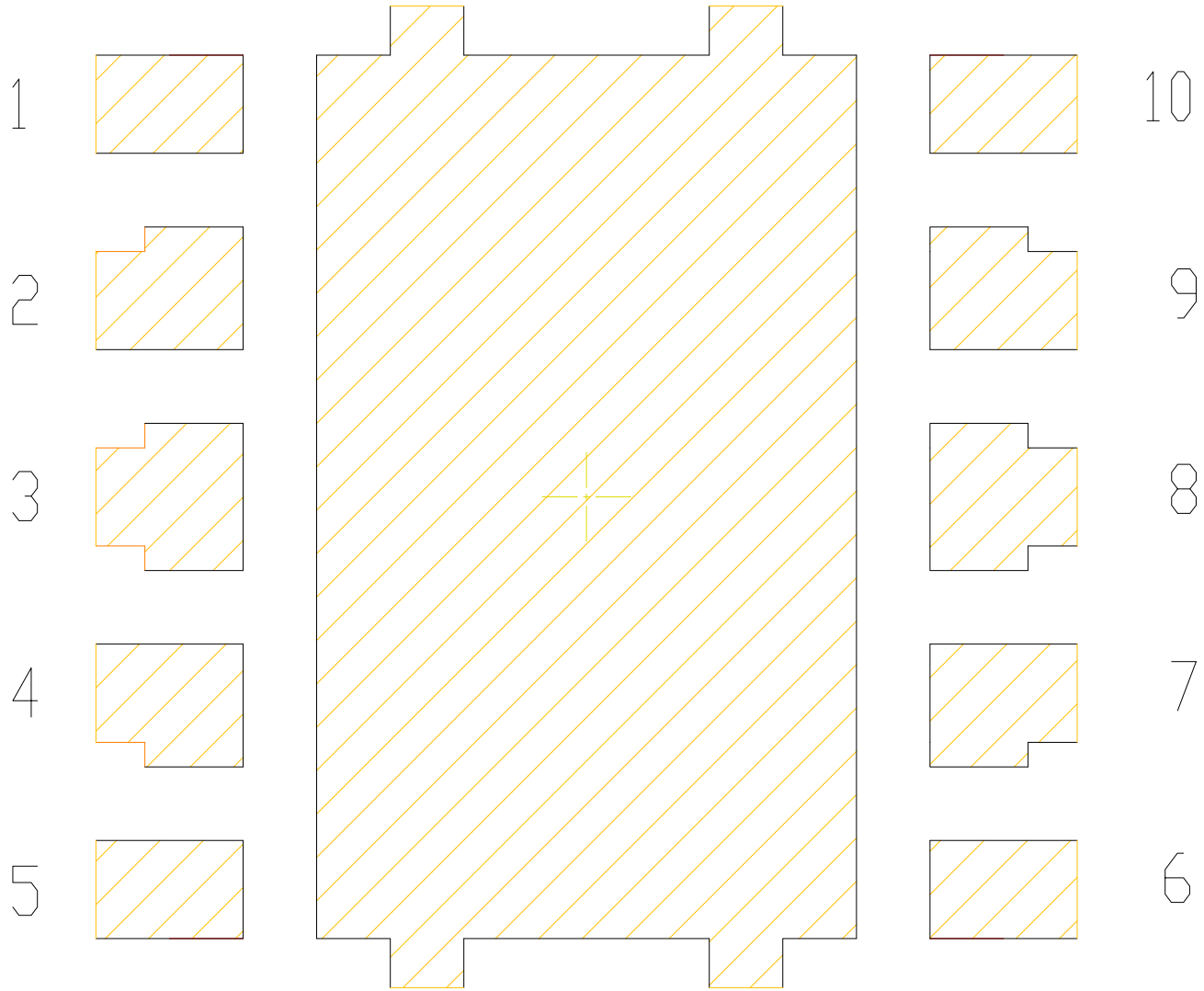



REVISIONS		
REV	DESCRIPTION	DATE
B	INITIAL RELEASE	4-1-2016



 NiPdAu PLATING

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CUSTOMER: xxxxx	DOCUMENT #:	 <a href="http://www.promex-ind.com">www.promex-ind.com</a>	
PROJECT NAME: xxxxx	DIE ATTACH PAD SIZE: 1.10 x 1.80 mm		
DIE SIZE, mm: xxxxx	EXPOSED PAD SIZE: 0.90 x 1.50 mm	TITLE DFN 10L 2x2 mm 0.40 PITCH BOND SHELL	
DIE THICKNESS, um: xxxxx	DAP PLATING OPTION: FULL PLATING		
BOND PAD PITCH, um: xxxxx	PLATING MATERIAL: NiPdAu	LEADFRAME P/N:	REV
BOND PAD OPENING, um: xxxxx	LEADFRAME MATERIAL: C194 FH	235-00095	A
WIRE SIZE, um: xxxxx	LEADFRAME THICKNESS: 0.203±0.0075 mm	DO NOT SCALE	FILE NAME 10L-DFN-2X2-40P-BD.DWG SHEET 1 OF 1